

Description

The SIS402DN-T1-GE3 uses advanced trench

technology to provide excellent $R_{DS(ON)}$, low gate

charge and operation with gate voltages as low

as 4.5V. This device is suitable for use as a

Battery protection or in other Switching application.

General Features

V_{DS} = 30V I_D =80 A

 $R_{DS(ON)} < 6 \text{ m}\Omega$ @V_{GS}=10V

Application

Battery protection

Load switch

Uninterruptible power supply

Package Marking and Ordering Information

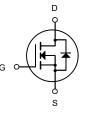
Product ID	Pack	Brand	Qty(PCS)
SIS402DN-T1-GE3	DFN3X3-8L	HXY MOSFET	5000

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	30	V
VGS	Gate-Source Voltage	±20	V
I₀@Tc=25°C	Continuous Drain Current, V _{GS} @ 10V ¹	80	А
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	50	А
IDM	Pulsed Drain Current ²	162	А
EAS	Single Pulse Avalanche Energy ³	144.7	mJ
IAS	Avalanche Current	53.8	А
P₀@Tc=25°C	Total Power Dissipation ⁴	62.5	W
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R₀JA	Thermal Resistance Junction-ambient ¹	62	°C/W
R₀JC	Thermal Resistance Junction-Case ¹	2.4	°C/W







N-Channel MOSFET



SIS402DN-T1-GE3

N-Channel Enhancement Mode MOSFET

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V
$\triangle BV_{DSS} / \triangle T_J$	BVDSS Temperature Coefficient	Reference to 25° C , I _D =1mA		0.0213		V/°C
R _{DS(ON)} S	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =30A		4.7	6	mΩ
		V _{GS} =4.5V , I _D =15A		5.9	8	
V _{GS(th)}	Gate Threshold Voltage		1.0	1.5	2.5	V
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$V_{GS}=V_{DS}$, $I_D=250$ uA		-5.73		mV/°C
	Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =25°C			1	- uA
I _{DSS}		V _{DS} =24V , V _{GS} =0V , T _J =55°C			5	
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =30A		26.5		S
R _g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.4	2.8	Ω
Qg	Total Gate Charge (4.5V)			31.6		
Q_gs	Gate-Source Charge	V _{DS} =15V , V _{GS} =4.5V , I _D =15A		8.6		nC
Q_{gd}	Gate-Drain Charge			11.7		
T _{d(on)}	Turn-On Delay Time			9		
Tr	Rise Time	V_{DD} =15V , V_{GS} =10V , R_{G} =3.3 Ω		19		ns
T _{d(off)}	Turn-Off Delay Time	I _D =15A		58		
T _f	Fall Time			15.2		
C _{iss}	Input Capacitance			3075	4000	
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		400	530	pF
C _{rss}	Reverse Transfer Capacitance			315		
Is	Continuous Source Current ^{1,5}				80	А
I _{SM}	Pulsed Source Current ^{2,5}	V _G =V _D =0V , Force Current			162	А
V_{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1	V
t _{rr}	Reverse Recovery Time	IF=30A , dl/dt=100A/µs ,		18		nS
Qrr	Reverse Recovery Charge			8		nC

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Note :

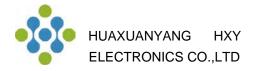
1. The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width $\,\leq\,$ 300us , duty cycle $\,\leq\,$ 2%

3.The EAS data shows Max. rating . The test condition is $V_{\text{DD}}\text{=}25\text{V}, V_{\text{GS}}\text{=}10\text{V}, \text{L=}0.1\text{mH}, \text{I}_{\text{AS}}\text{=}53.8\text{A}$

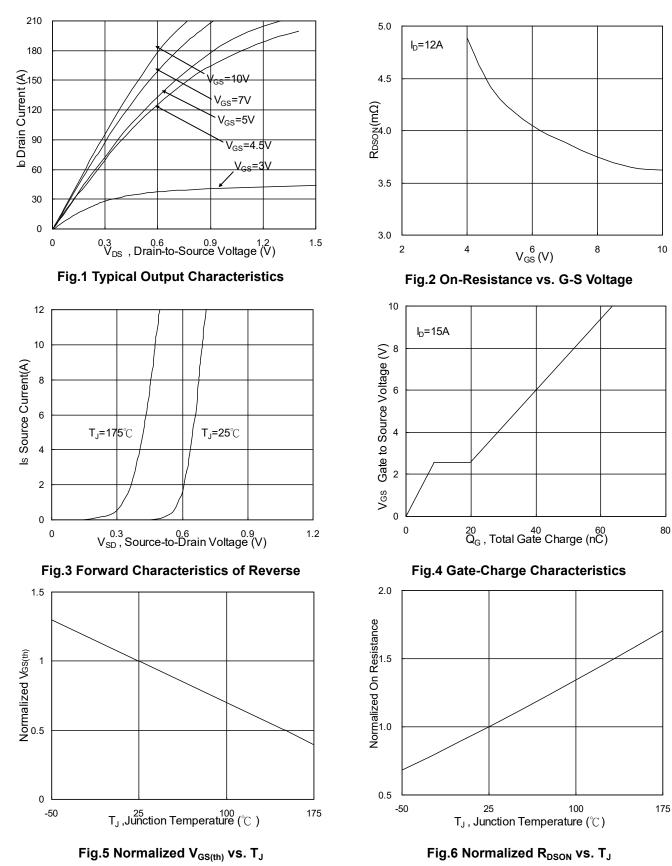
4. The power dissipation is limited by 175°C junction temperature

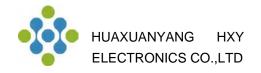
5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



SIS402DN-T1-GE3 N-Channel Enhancement Mode MOSFET

Typical Characteristics





SIS402DN-T1-GE3

N-Channel Enhancement Mode MOSFET

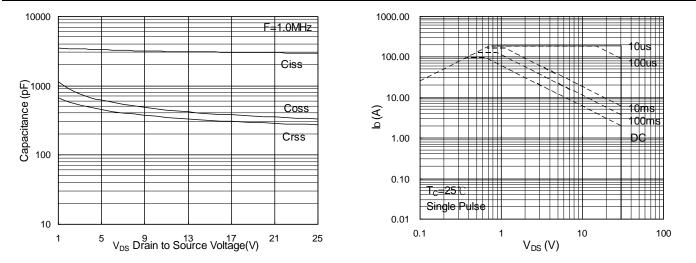




Fig.8 Safe Operating Area

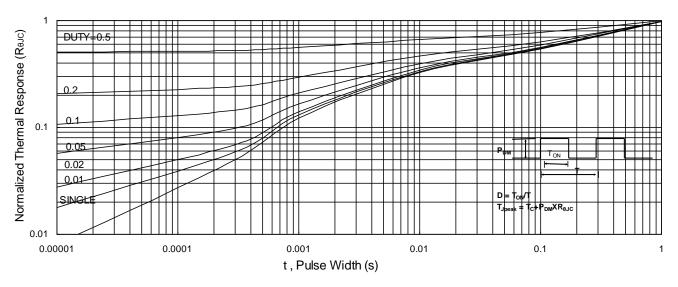


Fig.9 Normalized Maximum Transient Thermal Impedance

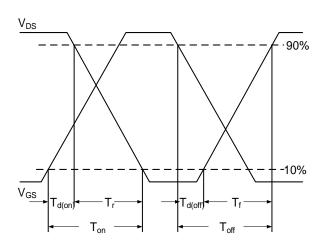


Fig.10 Switching Time Waveform

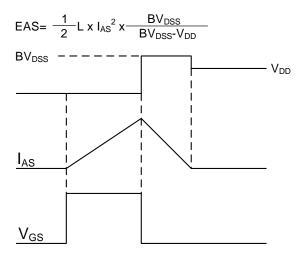
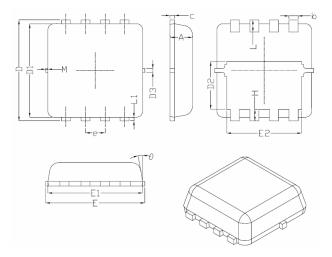


Fig.11 Unclamped Inductive Switching Waveform



DFN3X3-8L Package Information



Symbol	Dimensions In Millimeters		
	Min.	Nom.	Max.
A	0.70	0.75	0.80
b	0.25	0.30	0.35
С	0.10	0.15	0.25
D	3.25	3.35	3.45
D1	3.00	3.10	3.20
D2	1.48	1.58	1.68
D3	-	0.13	-
E	3.20	3.30	3.40
E1	3.00	3.15	3.20
E2	2.39	2.49	2.59
e	0.65BSC		
Н	0.30	0.39	0.50
L	0.30	0.40	0.50
L1	-	0.13	-
М	*	*	0.15
θ		10 [°]	12 [°]



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